Supplementary Material

Screen-printed Flexible Thermoelectric Device Based on Hybrid Silver Selenide/PVP Composite Films

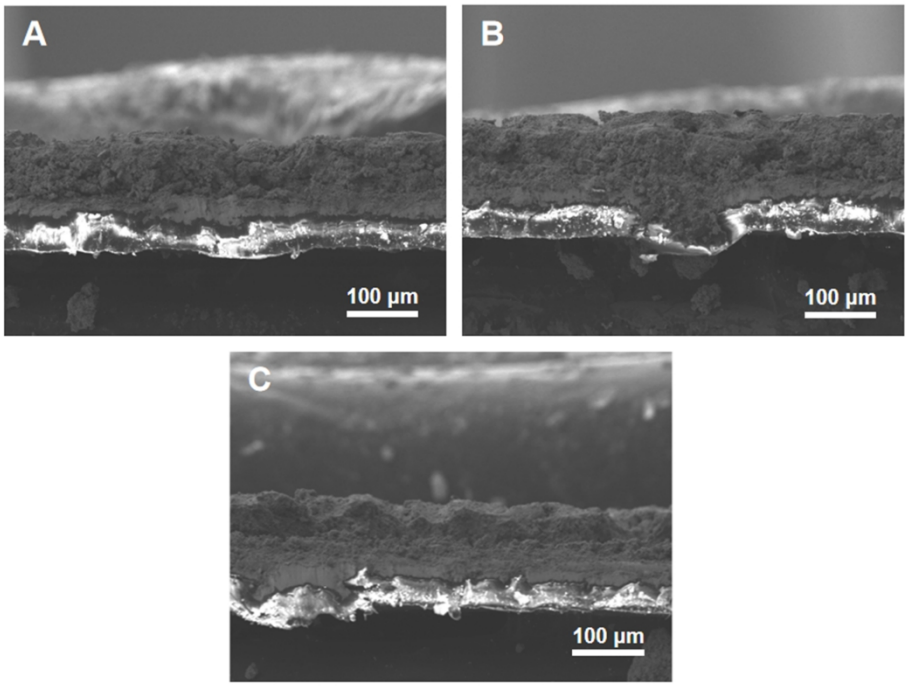

Figure S1. The field emission scanning electron microscope of PI10, PI20 and PI30 film thicknesses

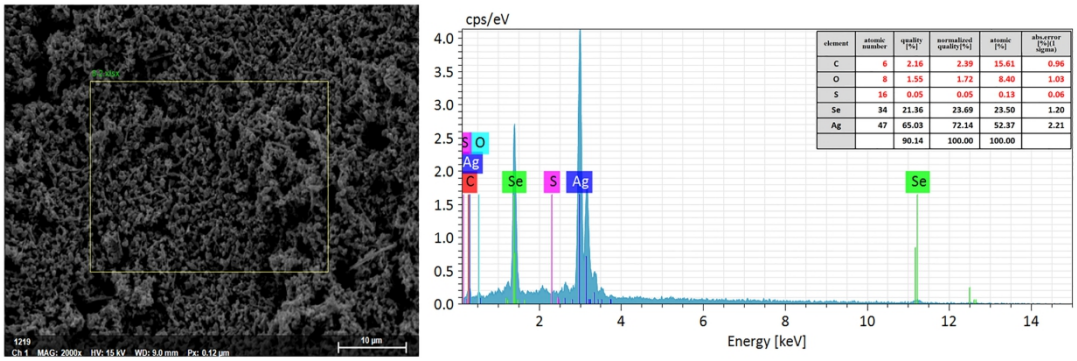

Figure S2. The energy dispersive spectrum analysis of the PI30 film

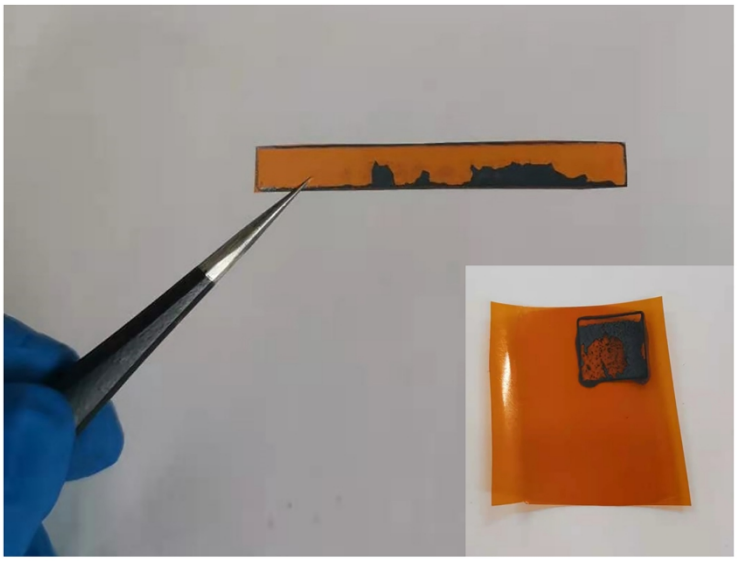

Figure S3. The image of a dry TEG module no longer adhering to the PI substrate

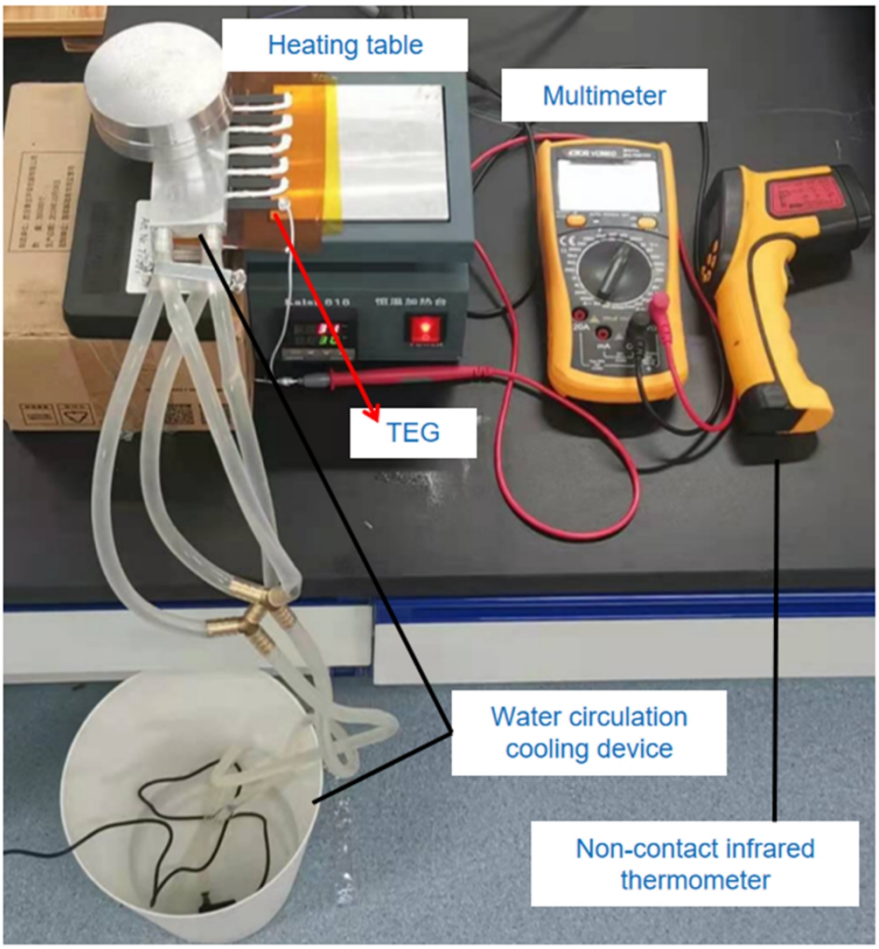

Figure S4. The image of F-TEG output performance measurement circuit